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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE


Applicant: Hong Yang et al.  
Serial No: 09/940,072  
Confirmation No: 3068  
Filed: August 27, 2001  
For: FABRICATION OF CERAMIC MICROSTRUCTURES

Examiner: Christopher A. Fiorilla  
Art Unit: 1731

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**RESPONSE**

Sir:

In response to the Office Action mailed August 12, 2003, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims that begins on page 2 of this amendment.

**Remarks** begin on page 9 of this amendment.

DO NOT  
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11/26/03  
CF